

Present and Mailing Address:

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Pranab Kumar Kundu

Research Interest

My major research interest is in the field of interfacial phenomena. Specifically the area of expertise is in the field of microscale transport involving change of phase heat transfer from micro-devices, characterization and quantification of the forces present in micro-scale systems. I work on the design and development of microscale heat spreaders for cooling of electronic components, which is one of the cutting edge researches in an area of contemporary interest.

Academic Qualifications

Exam/Degree	Institute/University	Year	Specialization	Remarks
Ph.D (Engg.)	Indian Institute of Technology, Kharagpur, India		Mechanical Engineering	Thesis submitted
M.E.	Jadavpur University, Kolkata, India	2002	Mechanical Engineering (Production Specialization)	1st Class
B.Tech.	Kalyani Government Engineering College, Kalyani, West Bengal, India. (University of Kalyani)	1999	Mechanical Engineering	1st Class
Higher Secondary (10+2)	WBCHSE	1995	Science	1st Division
Secondary (10)	WBBSE	1993	---	1st Division

Work Experience

Aug. 1999 – July 2000

Lecturer

Department of Mechanical Engineering
 Kalyani Government Engineering College, Kalyani, Nadia, W.B.
 Nature of work: Teaching and Lab Development

Jan. 2002 – July 2002

Lecturer

Department of Mechanical Engineering
 B. P. Poddar Institute of Management and Technology, Kolkata, W.B.
 Nature of work: Teaching, Research and Lab Development

July 2002 – Oct. 2007

Lecturer

Department of Mechanical Engineering
Heritage Institute of Technology, Kolkata, W.B.
Nature of work: Teaching, Research and Lab Development

Nov. 2007 – Sept. 2011

Project Officer

Sponsored Research and Industrial Consultancy, IIT Kharagpur
Project title: A Study of Microscale Transport Processes leading to the Development of a Cooling Strategy for Electronic Components
Funded by: Department of Information Technology, Govt. of India
Nature of work: Research and Lab Development

Oct. 2011 – Present

Senior Research Fellow

Sponsored Research and Industrial Consultancy, IIT Kharagpur
Project title: A Study of Microscale Transport Processes leading to the Development of a Cooling Strategy for Electronic Components
Funded by: Indian Space Research Organization, Govt. of India
Nature of work: Research and Lab Development

Awards and Recognitions

- National scholarship scheme merit certificate (for higher secondary result), West Bengal Govt. Education department, 1995.
- Qualified GATE 2000.
- Institute Fellowship Autumn Semester 2006 – 2007 in the Department of Mechanical Engineering of IIT Kharagpur.
- Institute Fellowship Autumn Semester 2006 – 2007 in the Department of Aerospace Engineering of IIT Kharagpur.

Membership of society/position held in society

- (i) Associate Member of Institute of Engineers (I); Membership no. AM093567-3.
- (ii) Life Member of Association of Engineers (I); Membership no. LM-350.

Thesis

- Ph. D** Fabrication and Performance Evaluation of On-Chip Micro Heat Pipe (Submitted to IIT Kharagpur)[†]
- M.E.** Computational Modelling of Heat and Mass transfer in Laser Surface Melting
- B.Tech.** On Grinding Wheel Performance Through Modified Grinding Fluid Application[†]

[†] Please see the annexure for a brief summary doctoral research work

Details of Foreign Visit

Research Visit

University of California, Irvine, CA, USA (June – July 2009).

Publications

Books

S. Sarkar and P. K. Kundu, “Engineering Mechanics”, Matrix Educare Pvt. Ltd., Kolkata – 6, India, ISBN 978-93-80221-01-4

S. Sarkar and P. K. Kundu, “Engineering Thermodynamics & Fluid Mechanics”, Matrix Educare Pvt. Ltd., Kolkata – 6, India, ISBN 978-93-80221-21-2

S. Sarkar and P. K. Kundu, “Thermal Power Engineering”, Matrix Educare Pvt. Ltd., Kolkata – 6, India, ISBN 978-93-80221-45-8

International Journal

P. K. Kundu, S. Chakraborty, S. DasGupta, “**Experimental Investigation of Enhanced Spreading and Cooling from a Micro-grooved Surface**”, *Microfluidics and Nanofluidics*, Volume 11, Number 4, 489-499, DOI: 10.1007/s10404-011-0814-5

P. K. Kundu, S. Mondal, S. Chakraborty, S. DasGupta, “**Experimental and Theoretical Evaluation of On-Chip Micro Heat Pipe**”, *Nanoscale and Microscale Thermophysical Engineering*, (accepted for publication on 27th December 2014). doi:10.1080/15567265.2014.1003342

International Conference

P. K. Kundu, S. Das, S. Sinha, P. P. Chowdhury, “**On Grinding Wheel Performance in Dry and Wet Conditions**” – Proc. 4th Int. Conf. On Mech. Engg., Dec.26-28, 2001, Mech. Engg. Dept., BUET, Dhaka, Bangladesh, Vol. IV, Sec. V, pp. 19-24.

P. K. Kundu, S. P. Chaudhuri, S. Chakraborty, “**Computational Modelling of Heat Transfer and Mass Transfer in Laser Surface Melting**” – Proc. 4th Workshop on Application of Laser in Mechanical Industry (WALMI), Feb.22-24, Dept. of Mech. Engg., Jadavpur University, Kolkata.

P. K. Kundu, S. P. Chaudhuri, S. Chakraborty, “**Cutting of Mild Steel Specimens in CO2 Laser**” - Proc. Int. Conf. On Manufacturing, Aug.9-11, 2002, Industrial & Production Engg. Dept., BUET, Dhaka, Bangladesh, Vol. I, pp. 519-526.

National Conference

P. K. Kundu, S. P. Chaudhuri, S. Chakraborty, “**Study on Temperature During Cutting of Low Carbon Steel Specimens in CO2 Laser**” – Proc. 20th AIMTDR Conf., Dec.13-15, 2002, Dept. of Prod. Engg., BIT Mesra, Ranchi, pp. 349-354.

P. K. Kundu, T. Das, A. Mohapatra, S. DasGupta and S. Chakraborty, “**Initiation of Super Hydrophobic Silicon Surface Using Electrostatic Self-Assembly**”, CHEMCON, Dec. 27-29, 2011, Bengaluru, India

T. Das, P. K. Kundu, S. DasGupta, S. Chakraborty, “**Analysis of Fluid Flow and Heat Transfer in Triangular Microgrooves**”, ChemBridge conference proceedings, Kolkata, 2012.

Product Development

An On-chip Micro Heat Pipe

Special Skill-set

Micro fabrications, Experimental Microfluidic, Transport phenomena, Ellipsometry.

List of Course/Training Attended

Title of the course	Nature of the course/workshop	Sponsoring/ Funding agency	Duration Of the course	Host /organizing institute
1 HRD Programme	Training	AICTE	October 13-16, 2004	Indian Heritage Academy and Heritage Institute of Technology
2 Recent advances in hydraulic control systems	Refresher course	UGC	June 20- July 9, 2005	Jadavpur University
3 Mechatronics, robotics & industrial automation	Short term course	TEQIP	January 2-7, 2006	Bengal Engineering & Science University, Shibpur
4 Special topics in fluid mechanics	Refresher course	UGC	January 1-21, 2007	Jadavpur University
5 Fundamental training on spectroscopic ellipsometry (basic+advanced)	Training	Ja Woollam co. Inc.	January 22-25, 2012	University of Mumbai and National Chemical Lab, Pune

List of Workshop/Training Program/Summer/Winter School Attended

1. **Int. Conf. On Mechanical Engineering**, BUET, Dhaka, Bangladesh, Dec. 26-28, 2001.
2. **16th National and 5th International ISHMT-ASME Heat and Mass Transfer Conference**, Jointly organized by Jadavpur University and B.E College (DU), Science City, Kolkata, Jan. 11-13, 2002.
3. **4th Workshop on Application of Laser in Mechanical Industry**, Jadavpur University, Kolkata, Feb. 22-24, 2002.
4. **Int. Conf. On Manufacturing**, BUET, Dhaka, Bangladesh, Aug. 9-11, 2002.
5. **20th AIMTDR Conference**, BIT, Mesra, Ranchi, Dec. 13-15, 2002.

6. **Conference on Advances and Recent Trends in Manufacturing (CARTM)**, Kalyani Government Engineering College, Kalyani, Nadia, November 14-15, 2003.
7. **5th Workshop on Application of Laser in Mechanical Industry**, Jadavpur University, Kolkata, Feb. 27-29, 2004.
8. **All India Workshop on Advances in Welding Science & Technology**, Bengal Engineering & Science University, July 22-23, 2005.
9. **Current Advances in Productivity Management**, Department of Production Engineering, Jadavpur University, July 25, 2005.
10. **International workshop on Engineering Fundamentals and Applications of Fuel cells**, Mechanical Engineering., Jadavpur University, January 9-10, 2008.
11. **Mechanics Over Micro and Nano Scales**, Bengal Engineering and Science University, Shibpur, December 21-22, 2009.
12. **Indo-US workshop on Fabrionics: The Science of Advanced Fabrication**, Jawaharlal Nehru Engineering College, Aurangabad, Dec 20-21, 2010.
13. **Fabrionics: Micro and Nano Scale Dynamics**, Bengal Engineering and Science University, Shibpur, August 18-19, 2012.
14. **22nd National and 11th International ISHMT-ASME Heat and Mass Transfer Conference**, organized by Indian Institute of Technology Kharagpur, Kharagpur, Dec. 28-31, 2013.

Personal Information

Father's Name : Rasamoy Kundu
 Date of Birth : 11th Day of January 1978
 Permanent Address : Andal more, Ukhra Road, Andal, Burdwan, WB, PIN 713321
 Marital status : Married
 Nationality : Indian
 Cast : General

References

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Dr. Sunando DasGupta

Professor, Chemical Engineering
 Indian Institute of Technology Kharagpur

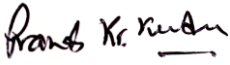
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Declaration

I do hereby declare that the information furnished above is true and complete to the best of my knowledge and belief.

Date : 15.02.2015
Place : Kharagpur


Pranab Kumar Kundu

ANNEXURE: A BRIEF SUMMARY OF DOCTORAL RESEARCH WORK

My PhD topic is “FABRICATION AND PERFORMANCE EVALUATION OF ON-CHIP MICRO HEAT PIPE”. The objectives of my PhD work are the design and fabrication of on-chip micro heat pipes using microchannels etched on the unused side of the semiconductor devices, followed by their characterization and performance analysis as the thermal performance of the micro heat pipe can be significantly enhanced by integrating it with the electronic component itself, leading to *on-chip micro heat pipes*, which are compact yet efficient.

Microchannels of different shapes and orientation are etched on double sided polished silicon wafer using standard lithography process (both wet etching and reactive ion etching) with masks designed specifically in AutoCAD 2007 and developed within a precision of 1 μm . Heat shock resistant Pyrex 7740 glass is used to cover the top of the micro channels with specially made connections for vacuum connection and coolant entry. The system is evacuated to a pressure of less than 6 mTorr for a period of 24 hours and then charged with a small amount (0.3 ml) of de-ionized water followed by thermal sealing to form the **on-chip micro heat pipe**. Additionally, the grooves and surfaces are characterized using atomic force and scanning electron microscopy.

In the microscopic analysis of spreading and cooling, a heat transfer cell is specifically designed and the shapes of the liquid menisci in the V-shaped microgrooves are accurately measured using image analyzing interferometry as functions of heat input. The relevant parameters e.g., the adsorbed film thickness, contact angle and curvature at the thicker end of the meniscus are accurately measured and used to explain the physics of the process. The temperature profiles are measured for the microgrooved and non-grooved silicon substrates under identical conditions of heat input and inclination. The axially averaged values of a dimensionless temperature are used to quantify the enhanced cooling and temperature homogenization potentials of microgrooved surfaces.

The performance and the cooling potential of the on-chip micro heat pipes are quantified by accurately measuring the temperature distributions along the channel length. The capillary suction capability of the fabricated micro heat pipe is evaluated by a mathematical model taking into account the capillary pressure driven flow in an evaporating curved microfilm as functions of temperature profile, groove geometry, thermo-physical properties, and contact angle. The numerical solutions of the governing equations provide additional insights into the complex process of flow and enhanced heat transfer in a micro heat pipe. The results establish that the fabricated on-chip micro heat pipes are efficient heat spreaders and are operating within the capillary limit without the occurrence of dry-out.